

### Ceramic Plate Series Thermoelectric Cooler

The CP14-127-045-L2-RT-W4.5 is a high-performance and highly reliable standard Thermoelectric Cooler. Assembled with Bismuth Telluride semiconductor material and thermally conductive Aluminum Oxide ceramics. It has a maximum Qc of 71.3 Watts when  $\Delta T=0$  and a maximum  $\Delta T$  of 70.5 °C at Qc = 0.

#### **Features**

- Compact geometric sizes
- DC Operation
- RoHS-compliant

#### **Applications**

- Thermoelectric Coolers for Reagent Storage
- Thermoelectric Coolers for Handheld Cosmetic Lasers
- Cooling for Centrifuges
- Heads-Up Displays, Imaging Sensors
- Peltier Cooling for Machine Vision

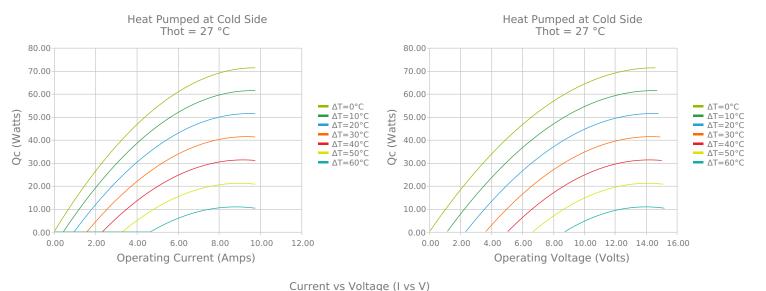


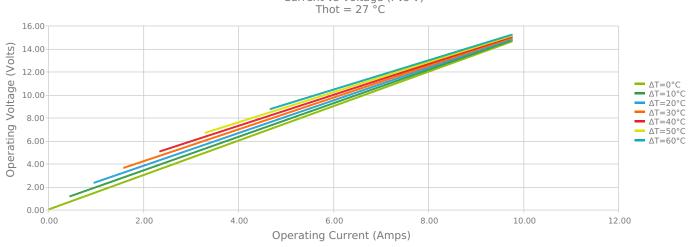
CERAMIC MATERIAL: Al<sub>2</sub>O<sub>3</sub> SOLDER CONSTRUCTION: 138°C, BiSn

INCHES [ MM ]

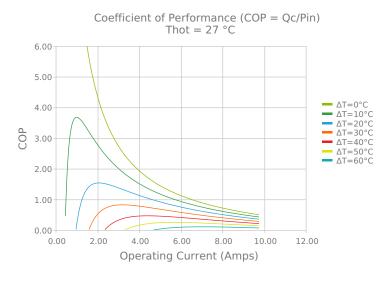
Note: Allow 0.020 in [0.5 mm] around perimeter of the thermoelectric cooler and lead wire attachment to accommodate sealant

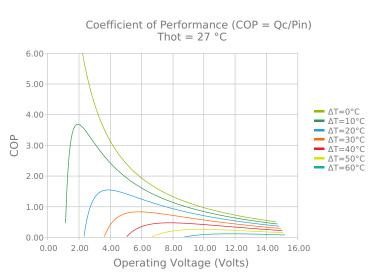
# **ELECTRICAL AND THERMAL PERFORMANCE**

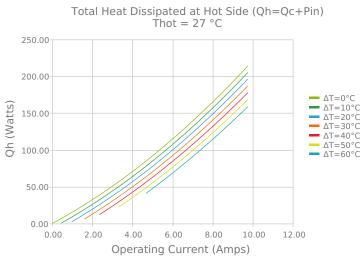


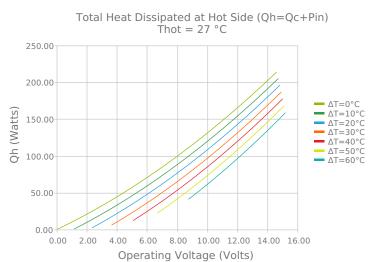


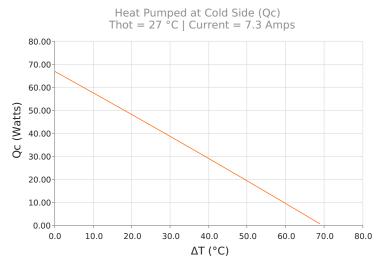


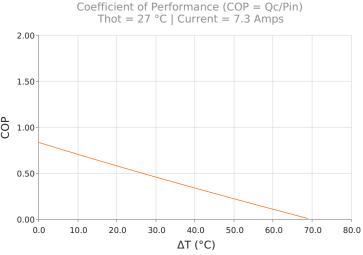














## **SPECIFICATIONS\***

**Hot Side Temperature** 

 $Qcmax (\Delta T = 0)$ 

 $\Delta T max (Qc = 0)$ 

Imax (I @ \Darkstrum \

Vmax (V @  $\Delta$ Tmax)

**Module Resistance** 

**Max Operating Temperature** 

Weight

27.0 °C	35.0 °C	50.0 °C
71.3 Watts	73.5 Watts	77.3 Watts
70.5°C	73.5°C	78.8°C
8.6 Amps	8.6 Amps	8.5 Amps
13.9 Volts	14.4 Volts	15.4 Volts
1.50 Ohms	1.56 Ohms	1.68 Ohms
80 °C		
20.0 gram(s)		

### **FINISHING OPTIONS**

Suffix	Thickness	Flatness / Parallelism	<b>Hot Face</b>	<b>Cold Face</b>	<b>Lead Length</b>
L2	3.327 ±0.013 mm 0.131 ± 0.0005 in	0.013 mm / 0.013 mm 0.0005 in / 0.0005 in	Lapped	Lapped	114.3 mm 4.50 in

## **SEALING OPTIONS**

Suffix	Sealant	Color	<b>Temp Range</b>	Description
RT	RTV	Translucent or White	-60 to 204°C	Non-corrosive, silicone adhesive

## **NOTES**

- 1. Max operating temperature: 80°C
- 2. Do not exceed Imax or Vmax when operating module
- 3. Reference assembly guidelines for recommended installation
- 4. Solder tinning also available on metallized ceramics

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<sup>\*</sup> Specifications reflect thermoelectric coefficients updated March 2020